

SN74LVC16373A-EP 16-BIT TRANSPARENT D-TYPE LATCH WITH 3-STATE OUTPUTS

DL PACKAGE

SCAS825-JUNE 2006

FEATURES

- Member of the Texas Instruments Widebus™ Family
- Operates From 1.65 V to 3.6 V
- Inputs Accept Voltages to 5.5 V
- Max t_{pd} of 4.2 ns at 3.3 V
- Typical V_{OLP} (Output Ground Bounce) <0.8 V at $V_{CC} = 3.3 \text{ V}, T_A = 25^{\circ}\text{C}$
- Typical V_{OHV} (Output V_{OH} Undershoot) >2 V at V_{CC} = 3.3 V, T_A = 25°C
- Ioff Supports Partial-Power-Down Mode Operation
- Supports Mixed-Mode Signal Operation (5-V Input and Output Voltages With 3.3-V V_{CC})
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 1000-V Charged-Device Model (C101)

DESCRIPTION/ ORDERING INFORMATION

This 16-bit transparent D-type latch is designed for 1.65-V to 3.6-V V_{CC} operation.

The SN74LVC16373A is particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers. The device can be used as two 8-bit latches or one 16-bit latch. When the latch-enable (LE) input is high, the Q outputs follow the data (D) inputs. When LE is taken low, the Q outputs are latched at the levels set up at the D inputs.

A buffered output-enable (OE) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without interface or pullup components.

ORDERING INFORMATION

T _A	PACKAGE ⁽¹)	ORDERABLE PART NUMBER	TOP-SIDE MARKING	
–55°C to 125°C	SSOP – DL	Tape and reel	CLVC16373AMDLREP	LVC16373AMEP	

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of the Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

	(TOP VI	EW)	
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DESCRIPTION/ORDERING INFORMATION (CONTINUED)

OE does not affect internal operations of the latch. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of this device as a translator in a mixed 3.3-V/5-V system environment.

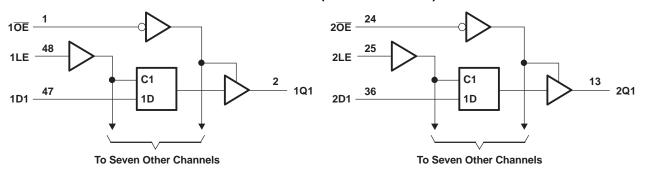
To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

This device is fully specified for partial-power-down applications using I_{off}. The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

I	NPUTS	5	OUTPUT
OE	LE	D	Q
L	Н	Н	Н
L	Н	L	L
L	L	Х	Q_0
н	Х	Х	Z

FUNCTION TABLE

LOGIC DIAGRAM (POSITIVE LOGIC)



Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V _{CC}	Supply voltage range		-0.5	6.5	V
VI	Input voltage range ⁽²⁾		-0.5	6.5	V
Vo	Voltage range applied to any output in t	Voltage range applied to any output in the high-impedance or power-off state $^{(2)}$			
Vo	Voltage range applied to any output in t	-0.5	V _{CC} + 0.5	V	
I _{IK}	Input clamp current	Input clamp current V _I < 0		-50	mA
I _{OK}	Output clamp current	V _O < 0		-50	mA
I _O	Continuous output current			±50	mA
	Continuous current through each V_{CC} of	r GND		±100	mA
θ_{JA}	Package thermal impedance ⁽⁴⁾	Package thermal impedance ⁽⁴⁾			
T _{stg}	Storage temperature range ⁽⁵⁾		-65	150	°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

(3) The value of V_{CC} is provided in the recommended operating conditions table.

(4) The package thermal impedance is calculated in accordance with JESD 51-7.

(5) Long-term high-temperature storage and/or extended use at maximum recommended operating conditions may result in a reduction of overall device life. See http://www.ti.com/ep_quality for additional information on enhanced plastic packaging.

Recommended Operating Conditions⁽¹⁾

			MIN	MAX	UNIT	
V	Supply voltage	Operating	1.65	3.6	V	
V _{CC}	Supply voltage	Data retention only	1.5		v	
		V _{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$			
V _{IH}	High-level input voltage	V_{CC} = 2.3 V to 2.7 V	1.7		V	
		$V_{CC} = 2.7 V \text{ to } 3.6 V$	2			
		V _{CC} = 1.65 V to 1.95 V		$0.35 \times V_{CC}$		
VIL	Low-level input voltage	V_{CC} = 2.3 V to 2.7 V		0.7	V	
		V_{CC} = 2.7 V to 3.6 V		0.8		
VI	Input voltage		0	5.5	V	
	Output uphana	High or low state	0	V _{CC}	V	
Vo	Output voltage	High-impedance state			V	
		V _{CC} = 1.65 V		-4		
	Llich lough output ourroat	V _{CC} = 2.3 V		-8	mA	
I _{OH}	High-level output current	$V_{CC} = 2.7 V$		-12	mA	
		$V_{CC} = 3 V$		-24		
		V _{CC} = 1.65 V		4		
		$V_{CC} = 2.3 V$		8	mA	
I _{OL}	Low-level output current	$V_{CC} = 2.7 V$		12		
		$V_{CC} = 3 V$		24		
Δt/Δv	Input transition rise or fall rate			10	ns/V	
T _A	Operating free-air temperature		-55	125	°C	

 All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

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Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		V _{cc}	MIN	TYP ⁽¹⁾ MAX	UNIT
	I _{OH} = -100 μA		1.65 V to 3.6 V	$V_{CC} - 0.2$		
	$I_{OH} = -4 \text{ mA}$		1.65 V	1.2		
M	$I_{OH} = -8 \text{ mA}$		2.3 V	1.7		V
V _{OH}	1. 12 mA		2.7 V	2.2		v
	$I_{OH} = -12 \text{ mA}$		3 V	2.4		
	$I_{OH} = -24 \text{ mA}$		3 V	2.2		
	I _{OL} = 100 μA		1.65 V to 3.6 V		0.2	
	I _{OL} = 4 mA		1.65 V		0.45	
V _{OL}	I _{OL} = 8 mA		2.3 V		0.7	V
	I _{OL} = 12 mA		2.7 V		0.4	
	I _{OL} = 24 mA		3 V		0.55	
I _I	V _I = 0 to 5.5 V		3.6 V		±5	μA
I _{off}	$V_{I} \text{ or } V_{O} = 5.5 \text{ V}$		0		±10	μA
I _{OZ}	$V_{O} = 0$ to 5.5 V		3.6 V		±10	μA
I	V _I = V _{CC} or GND		2.6.1/		20	۸
I _{CC}	$3.6 \text{ V} \le \text{V}_1 \le 5.5 \text{ V}^{(2)}$	$I_{O} = 0$	3.6 V		μA	
ΔI_{CC}	One input at V_{CC} – 0.6 V, Other inputs at V_{CC} or GND		2.7 V to 3.6 V	500		μA
C _i	V _I = V _{CC} or GND		3.3 V		5	pF
Co	$V_{O} = V_{CC}$ or GND		3.3 V		6.5	pF

Timing Requirements

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

		V _{CC} = 2 ± 0.2	V _{CC} = 2.5 V ± 0.2 V		$V_{CC} = 2.7 V$		3.3 V V	UNIT
		MIN	MAX	MIN	МАХ	MIN	MAX	
t _w	Pulse duration, LE high	3.3		3.3		3.3		ns
t _{su}	Setup time, data before LE \downarrow	1.7		1.7		1.7		ns
t _h	Hold time, data after LE \downarrow	1.6		1.6		1.6		ns

Switching Characteristics

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC} = 2.5 V \pm 0.2 V		V _{CC} = 2.7 V		V _{CC} = 3.3 V ± 0.3 V		UNIT
	(INFOT)	(001F01)	MIN	MAX	MIN	MAX	MIN	MAX	
	D	Q	1	5.2	1	4.9	1.6	4.2	ns
t _{pd}	LE		1	5.2	1	5.3	1.3	4.6	
t _{en}	ŌĒ	Q	1	7.7	1	6.2	1.3	5.3	ns
t _{dis}	ŌĒ	Q	1	5.2	1	6.3	2.1	5.9	ns

Operating Characteristics

 $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	V _{CC} = 1.8 V TYP	V _{CC} = 2.5 V TYP	V _{CC} = 3.3 V TYP	UNIT		
C	Power dissipation capacitance	Outputs enabled	f = 10 MHz	32	35	39	pF	
C _{pd}	per latch	Outputs disabled		4	4	6	рн	

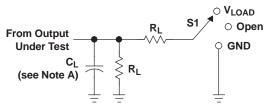
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VI

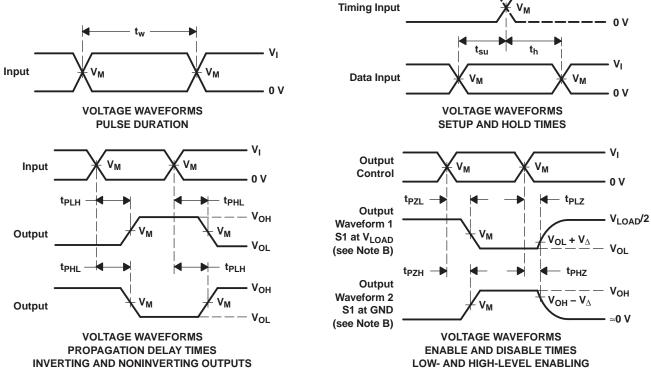
PARAMETER MEASUREMENT INFORMATION



TEST	S1
t _{PLH} /t _{PHL}	Open
t _{PLZ} /t _{PZL}	V _{LOAD}
t _{PHZ} /t _{PZH}	GND

LOAD CIRCUIT

V	INF	PUTS		N	•		
V _{CC}	VI	t _r /t _f	VM	V _{LOAD}	CL	RL	
$\textbf{2.5 V} \pm \textbf{0.2 V}$	V _{CC}	≤2 ns	V _{CC} /2	$2 \times V_{CC}$	50 pF	500 Ω	0.15 V
2.7 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V
3.3 V \pm 0.3 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_{O} = 50 Ω
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. t_{PZL} and t_{PZH} are the same as t_{en} .
- G. t_{PLH} and t_{PHL} are the same as t_{pd} .
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms



10-Dec-2020

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
CLVC16373AMDLREP	ACTIVE	SSOP	DL	48	1000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	LVC16373AMEP	Samples
V62/06649-01XE	ACTIVE	SSOP	DL	48	1000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	LVC16373AMEP	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

10-Dec-2020

OTHER QUALIFIED VERSIONS OF SN74LVC16373A-EP :

• Catalog: SN74LVC16373A

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION

REEL DIMENSIONS

TEXAS INSTRUMENTS





TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

TAPE AND REEL INFORMATION

*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
CLVC16373AMDLREP	SSOP	DL	48	1000	330.0	32.4	11.35	16.2	3.1	16.0	32.0	Q1

TEXAS INSTRUMENTS

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PACKAGE MATERIALS INFORMATION

14-Jul-2012



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
CLVC16373AMDLREP	SSOP	DL	48	1000	367.0	367.0	55.0

DL (R-PDSO-G48)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MO-118

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